

### ➤ General Description

This PAN3018S Dual N-Channel enhancement mode power field effect transistor is the high density trench technology and this advanced technology can provide excellent  $R_{ds(On)}$  performance and efficiency for power switching and load switching application., this device also comply with the RoHS and Green Product requirement with full function reliability approved.

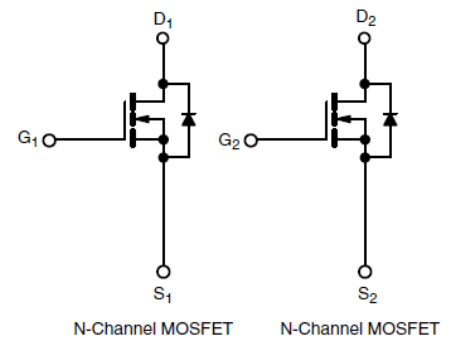
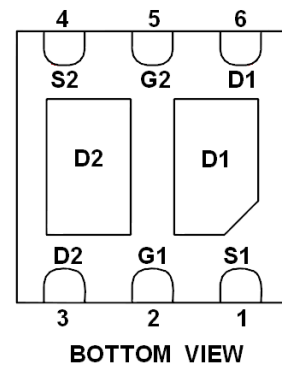
### ➤ Feature

- Super high density cell design for extremely low  $R_{DS(ON)}$
- Exceptional on-resistance and maximum DC current capability
- DFN2X2-6L package design

### ➤ Application

- Load Switch with Low Voltage Drop
- Load Switch for 1.2 V/1.5 V/1.8 V Power Lines
- Smart Phones, Tablet PCs, Portable Media Players

### ➤ DFN2X2-6L



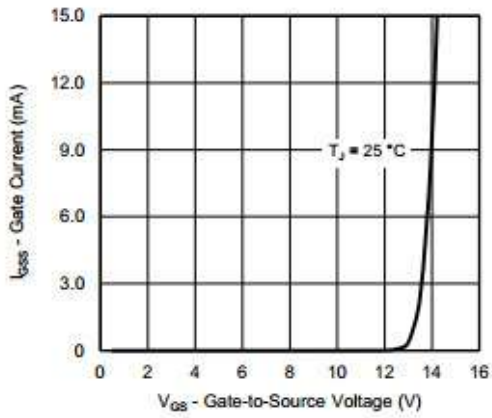
### ➤ Absolute Maximum Ratings

Parameter	Symbol	Rating	Unit	
Drain-Source Voltage	$V_{DSS}$	30	V	
Gate –Source Voltage	$V_{GSS}$	$\pm 12$	V	
Continuous Drain Current( $T_J=150^\circ C$ )	$I_D$	$T_C=25^\circ C$	4.5	A
		$T_C=70^\circ C$	4.5	
		$T_A=25^\circ C$	4.4	
		$T_A=70^\circ C$	3.5	
Pulsed Drain Current	$I_{DM}$	15	A	
Continuous Source Current(Diode Conduction)	$I_S$	1.6	A	
Power Dissipation	$P_D$	$T_C=25^\circ C$	7.8	W
		$T_C=70^\circ C$	5.0	
Operating Junction Temperature	$T_J$	150	$^\circ C$	
Storage Temperature Range	$T_{STG}$	-55/150	$^\circ C$	
Thermal Resistance-Junction to Ambient	$R_{\theta JA}$	52	$^\circ C/W$	
Thermal Resistance-Junction to Case(Drian)	$R_{\theta JC}$	12.5		

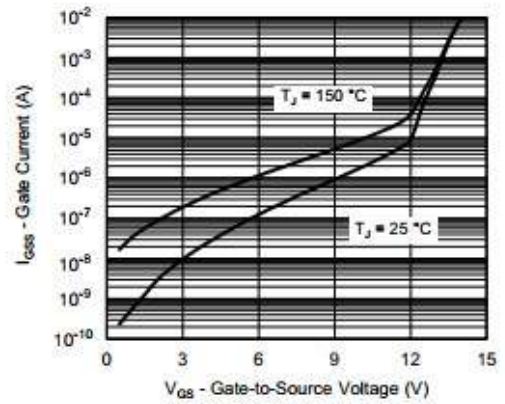
➤ **Electrical Characteristics ( $T_A=25^\circ C$  Unless otherwise noted)**

Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
<b>Static</b>						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS}=0V, I_D=250\mu A$	30			V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	0.6		1.0	
Gate Leakage Current	$I_{GSS}$	$V_{DS}=0V, V_{GS}=\pm 12V$			$\pm 100$	nA
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS}=24V, V_{GS}=0V$			1	uA
		$V_{DS}=24V, V_{GS}=0V$ $T_J=85^\circ C$			30	
On-State Drain Current	$I_{D(on)}$	$V_{DS} \geq 5V, V_{GS}=4.5V$	30			A
Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=4.0A$		36	50	mΩ
		$V_{GS}=4.5V, I_D=3.0A$		40	56	
		$V_{GS}=2.5V, I_D=2.5A$		49	64	
		$V_{GS}=1.8V, I_D=1.0A$		61	76	
Forward Transconductance	$g_{FS}$	$V_{DS}=15V, I_D=3.0A$		15		S
Diode Forward Voltage	$V_{SD}$	$I_S=2.0A, V_{GS}=0V$		0.8	1.2	V
<b>Dynamic</b>						
Total Gate Charge	$Q_g$	$V_{DS}=15V, V_{GS}=4.5V$ $I_D \equiv 10A$		3.6	5.5	nC
Gate-Source Charge	$Q_{gs}$			0.5		
Gate-Drain Charge	$Q_{gd}$			0.5		
Input Capacitance	$C_{iss}$	$V_{DS}=15V, V_{GS}=0V$ $f=1MHz$		320		pF
Output Capacitance	$C_{oss}$			45		
Reverse Transfer Capacitance	$C_{rss}$			20		
Turn-On Time	$t_{d(on)}$	$V_{DD}=15V, R_L=5\Omega$ $I_D \equiv 3.0A, V_{GEN}=4.5V$ $R_G=1\Omega$		5	10	ns
	$t_r$			30	60	
Turn-Off Time	$t_{d(off)}$			30	60	
	$t_f$			40	80	

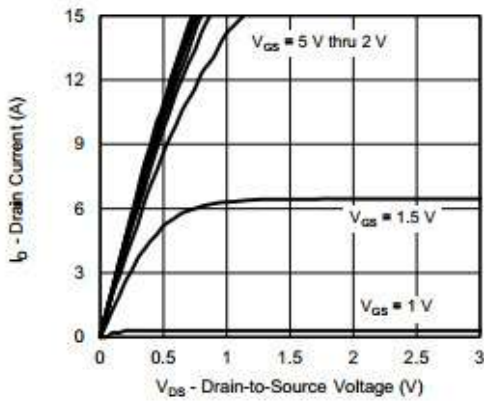
## ➤ Typical Characteristics



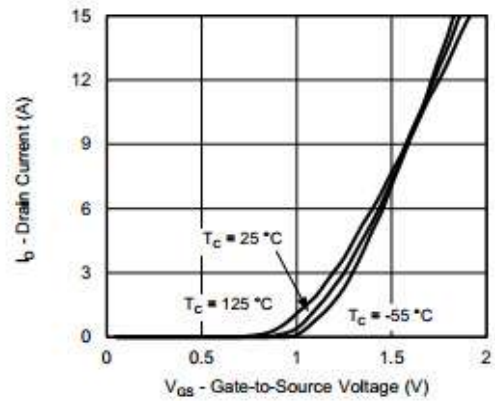
Gate Current vs. Gate-Source Voltage



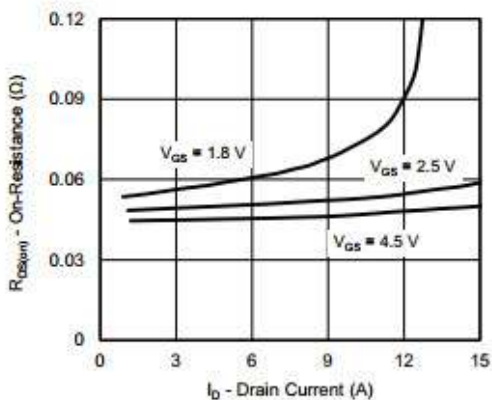
Gate Current vs. Gate-Source Voltage



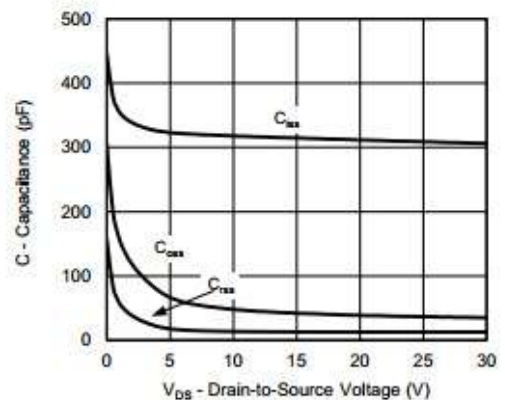
Output Characteristics



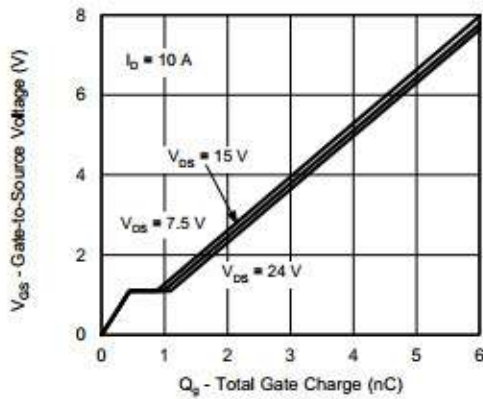
Transfer Characteristics



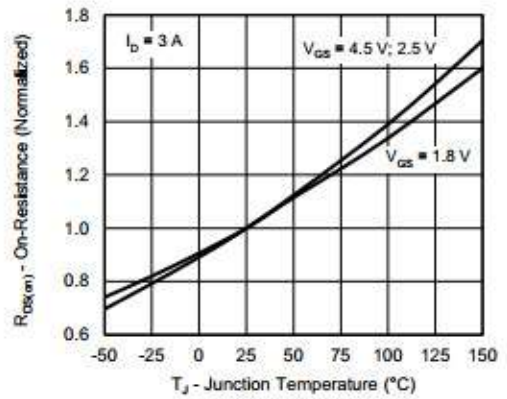
On-Resistance vs. Drain Current and Gate Voltage



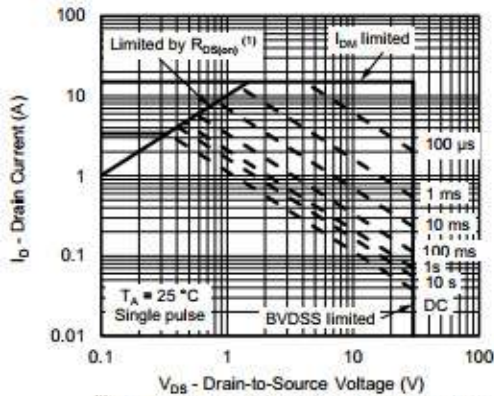
Capacitance



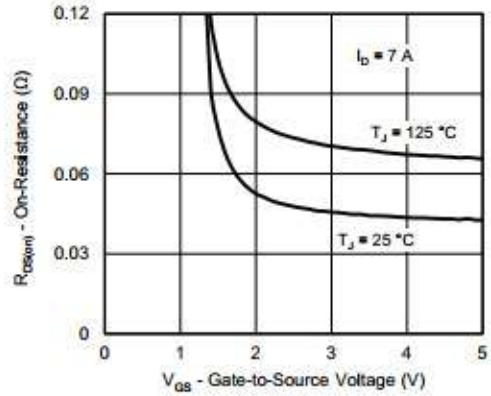
Gate Charge



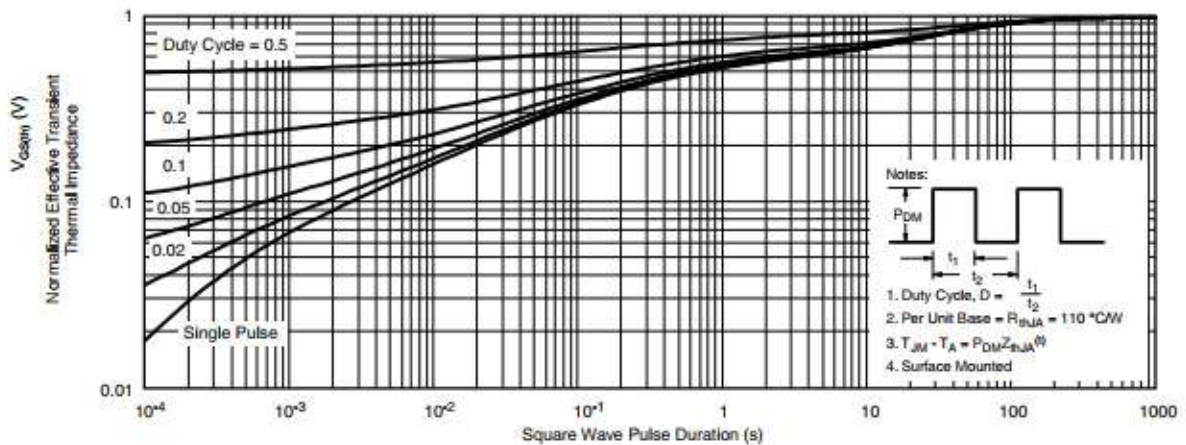
On-Resistance vs. Junction Temperature



Safe Operating Area, Junction-to-Ambient



On-Resistance vs. Gate-to-Source Voltage



Normalized Thermal Transient Impedance, Junction-to-Ambient

### ➤ Recommend IR Reflow Soldering Thermal Profile

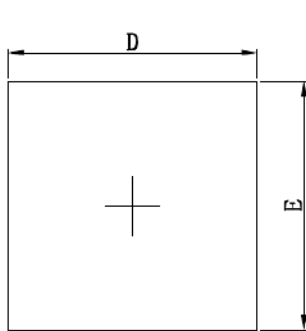


Profile Feature	Pb-Free Assembly Profile
Temperature Min. ( $T_{smin}$ )	150°C
Temperature Max. ( $T_{smax}$ )	200°C
Time ( $t_s$ ) from ( $T_{smin}$ to $T_{smax}$ )	60-120 seconds
Average Ramp-up Rate ( $t_L$ to $t_P$ )	3°C/second max.
Liquidous Temperature ( $T_L$ )	217°C
Time ( $t_L$ ) Maintained Above ( $T_L$ )	60 – 150 seconds
Peak Temperature	260°C +0°C / -5°C
Time ( $t_P$ ) within 5°C of actual Peak Temperature	30 seconds
Ramp-down Rate ( $T_P$ to $T_L$ )	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.

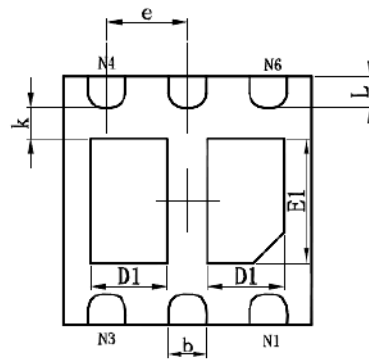
### ➤ Ordering Information

Part Number	Description	Quantity
PAN3018S	DFN2X2-6L Reel	4000 pcs

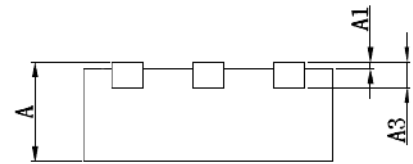
### ➤ Package Information (DFN2X2-6L)



**Top View**



**Bottom View**



**Side View**

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.700/0.800	0.800/0.900	0.028/0.031	0.031/0.035
A1	0.000	0.050	0.000	0.002
A3	0.203REF.		0.008REF.	
D	1.924	2.076	0.076	0.082
E	1.924	2.076	0.076	0.082
D1	0.520	0.720	0.020	0.028
E1	0.900	1.100	0.035	0.043
k	0.200MIN.		0.008MIN.	
b	0.250	0.350	0.010	0.014
e	0.650TYP.		0.026TYP.	
L	0.174	0.326	0.007	0.013

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